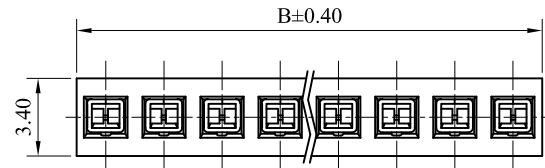


REV.	ECO. NO.	DESCRIPTION	DATE
B	E000192		
C	ES060324		
D	ES071009		
E	ES101227		
F	ES150711	Change 3.5mm into 3.2mm in C3 area	
G	ES220604	Material change:TBP→High Temperature Delete inch dimension	22.06.30



Material:
 Insulator: High Temperature Thermoplastic, UL94V-0,Black
 Contact: Phosphor Bronze

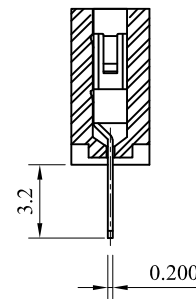
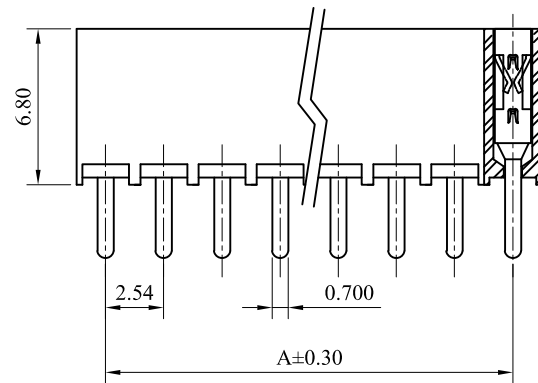
General Part Number:

2694S **V* 00
 1 2

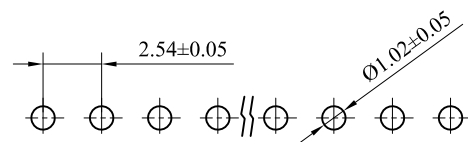
1.No.of circuits (03~40)

2.Plating

- T= Tin plated 120μ " min over 30μ "min,Nickel overall
- F= Selective Gold flash on contact area over 30μ" min. Nickel overall,
Tin plated on solder or other area
- J= 15μ"min. Selective Gold on contact area over 30μ" min.Nickel overall,
Tin plated on solder or other area
- U= Gold flash over 30u" min. Nickel underplating overall
- K= 30μ" min.Selective Gold on contact area over 30μ" min.
Nickel underplating overall,Tin plated on solder tails



A=2.54mm *No.of spaces
 B=A+3.04mm



Recommended PCB Layout

TOLERANCE UNLESS OTHERWISE SPECIFIED			LEOCO CORPORATION http://www.leoco.com.tw			
mm	mm	inch	APPROVED BY: Chard	DATE: 2022.06.30	TITLE: Socket	
1 PLACE	± 0.30	± ---	CHECKED BY: Spring	DATE: 2022.06.30		
2 PLACES	± 0.20	± ---	DRAWN BY: Janey	DATE: 2022.06.30	PART NO.: 2694S**V*00	
3 PLACES	± 0.10	± ---	SIZE: A3	SCALE: 1:1	DRAWING NO.: 269402S	
4 PLACES	± ---	± ---	ANGULAR ±1°		REV.: G	SHEET: 1 OF 1